

**3.0V, SOTiny™ 0.8Ω Dual SPDT Analog Switch
with -1.0V to 4.2V Operating Range**
Features

- Analog Signal Range: -1.0V to V_{DD} when switch is “ON”
- -1.0V Undershoot Protection when switch is “OFF”
- CMOS Technology for Bus and Analog Applications
- Low On-Resistance: 0.8Ω (+3.3V Supply)
- Wide V_{DD} Range: 1.5V to 4.2V ±10%
- Low Power Consumption : 5µW
- Rail-to-Rail switching throughout Signal Range
- Fast Switching Speed: 50ns max. at 3.3V
- High Off Isolation: -50dB at 1 MHz
- -45dB (1 MHz) Crosstalk Rejection Reduces Signal Distortion
- Break-Before-Make Switching
- Extended Industrial Temperature Range: -40°C to 85°C
- Packaging: (Pb-free & Green)
-12-contact TDFN (ZE)

Applications

- Cell Phones
- PDAs
- Portable Instrumentation
- Battery Powered Communications
- Computer Peripherals

Pin Description

Pin Number	Name ^(1,2,3)	Description
8, 11	NO _x	Data Port (Normally Open)
3, 6	GND _x	Ground
2, 5	NC _x	Data Port (Normally Closed)
1, 4	COM _x	Common Output/Data Port
9, 12	V _{DD_x}	Positive Power Supply ⁽¹⁾
7, 10	IN _x	Logic Control

Notes:

1. X = 0 or 1
2. V_{DD0} and V_{DD1} are not internally connected. Each must be powered separately.
3. GND₀ and GND₁ are not internally connected. Each must be powered separately.

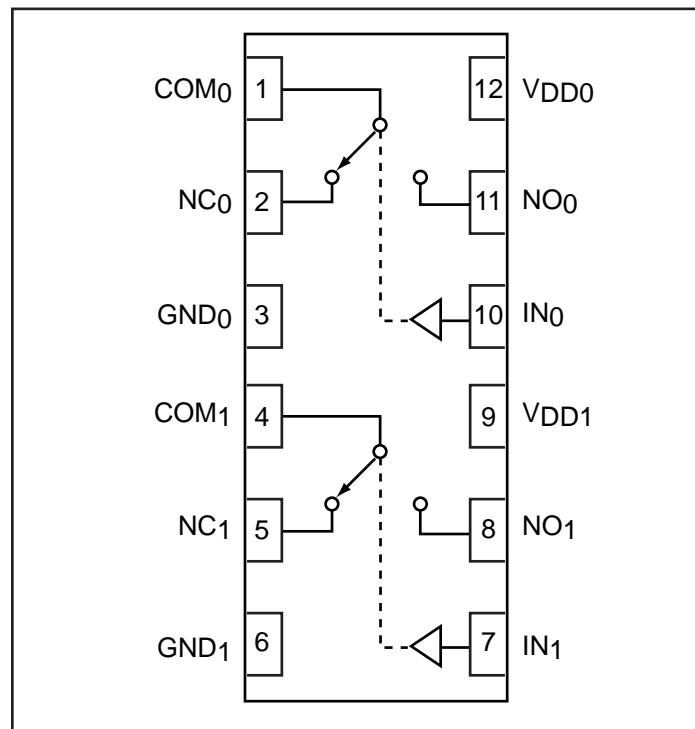
Description

The PI3A3160C is a high-bandwidth, fast Dual single-pole double-throw (SPDT) CMOS switch. It can be used as an analog switch or as a low-delay bus switch. Specified over a wide operating power supply voltage range, 1.5V to 4.2V ±10%, the switch has a typical On-Resistance of 0.8Ω at 3.3V.

Break-before-make switching prevents both switches from being enabled simultaneously. This eliminates signal disruption during switching.

Control inputs, IN, tolerates input drive signals up to 3.3V, independent of supply voltage.

PI3A3160C is a lower voltage and On-Resistance replacement for the PI5A3158.

Block Diagram / Pin Configuration

Function Table

Logic Input	Function
0	NC _x Connected to COM _x
1	NO _x Connected to COM _x

Absolute Maximum Ratings

Voltages Referenced to GND

V_{DD} -0.5V to 4.6V

V_{IN}, V_{COM}, V_{NC}, V_{NO}⁽¹⁾ -1.5V to V_{DD} +0.3V
 or 30mA, whichever occurs first

Current (any terminal) ±200mA

Peak Current, COM, NO, NC
 (Pulsed at 1ms, 10% duty cycle) ±400mA

Temp Range -40°C to +85°C

Thermal Information

Continuous Power Dissipation

TDFN-12 (derate 7.1mW/°C above +70°C) 0.5W

Storage Temperature -65°C to +150°C

Lead Temperature (soldering, 10s) +300°C

Notes:

1. Signals on NC, NO, COM, or IN exceeding V_{DD} or GND are clamped by internal diodes. Limit forward diode current to 30mA.

Caution: *Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied.*

Electrical Specifications - Single +3.3V Supply

(V_{DD} = +3.3V ± 10%, GND = 0V, V_{IH} = 1.4V, V_{IL} = 0.5V)

Parameter	Symbol	Conditions	Min. ⁽¹⁾	Typ. ⁽²⁾	Max. ⁽¹⁾	Units
Analog Switch						
Analog Signal Range ⁽³⁾	V _{ANALOG}		-1.0		V _{DD}	V
On-Resistance	R _{ON}	V _{DD} = 2.7V, I _{COM} = 100mA, V _{NO} or V _{NC} = +1.5V			1.3	Ω
On-Resistance Match Between Channels ⁽⁴⁾	ΔR _{ON}				0.15	
On-Resistance Flatness ⁽⁵⁾	R _{FLAT(ON)}	V _{DD} = 2.7V, I _{COM} = 100mA, V _{NO} or V _{NC} = 0.8V, 2.0V			0.1	
NO or NC Off Leakage Current ⁽⁶⁾	I _{NO(OFF)} or I _{NC(OFF)}	V _{DD} = 3.3V, V _{COM} = 0V, V _{NO} or V _{NC} = +2.0V	-2		2	μA
COM On Leakage Current ⁽⁶⁾	I _{COM(ON)}	V _{DD} = 3.3V, V _{COM} = +2.0V, V _{NO} or V _{NC} = +2.0V	-2		2	

Notes:

1. The algebraic convention, where most negative value is a minimum and most positive is a maximum, is used in this data sheet.
 $T_A = 40^\circ\text{C}$ to $+85^\circ\text{C}$.
2. Typical values are for DESIGN AID ONLY, not guaranteed or subject to production testing.
 Typical values are tested w $T_A = 25^\circ\text{C}$
3. Guaranteed by design.
4. $\Delta R_{ON} = R_{ON} \text{ max.} - R_{ON} \text{ min.}$
5. Flatness is defined as the difference between the maximum and minimum value of On-Resistance measured.
6. Leakage parameters are 100% tested at maximum rated hot temperature and guaranteed by correlation at $+25^\circ\text{C}$.

Electrical Specifications - Single +3.3V Supply (continued)

 (V_{DD} = +3.3V ± 10%, GND = 0V, V_{IH} = 1.4V, V_{IL} = 0.5V)

Parameter	Symbol	Conditions	Min. ⁽¹⁾	Typ. ⁽²⁾	Max. ⁽¹⁾	Units
Logic Input						
Input High Voltage	V _{IH}	Guaranteed Logic High Level	1.4			V
Input Low Voltage	V _{IL}	Guaranteed Logic LowLevel			0.5	
Input Current with Voltage High	I _{INH}	V _{IN} = V _{DD} , all others = 0V	-1		1	μA
Input Current with Voltage Low	I _{INL}	V _{IN} = 0V, all others = V _{DD}	-1		1	
Dynamic						
Turn-On-Time	t _{ON}	V _{DD} = 3.3V, V _{NO} or V _{NC} = 2.0V, Figure 1			50	ns
Turn-Off-Time	t _{OFF}				50	
Break-Before-Make	t _{BBM}	Figure 3	1		20	
Charge Injection ⁽³⁾	Q	C _L = 1nF, V _{GEN} = 0V, R _{GEN} = 0Ω, Figure 2		110		pC
Off Isolation ⁽⁴⁾	O _{IRR}	R _L = 50Ω, f = 1 MHz, Figure 4		-50		dB
CrossTalk ⁽⁵⁾	X _{TALK}	R _L = 50Ω, f = 1 MHz, Figure 5				
NC or NO OffCapacitance	C _{NC/NO} (OFF)	f = 1 MHz, Figure 6		35		pF
COM On Capacitance	C _{COM(ON)}	f = 1 MHz, Figure 7		110		
Control Input Capacitance	C _{IN}	f = 1 MHz		1		
-3dB Bandwidth	B _W	NO or NC to COM		65		MHz
Supply						
Power Supply Range	V _{DD}		1.5		4.6	V
Positive Supply Current	I _{CC}	V _{DD} = 4.6V, V _{IN} = 0V or V _{DD}	210	280	350	μA

Notes:

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 $T_A = 40^\circ\text{C}$ to $+85^\circ\text{C}$.
2. Typical values are for DESIGN AID ONLY, not guaranteed or subject to production testing.
 Typical values are tested w/ $T_A = 25^\circ\text{C}$
3. Guaranteed by design..
4. Off Isolation = $20\log_{10} [V_{COM} / (V_{NO} \text{ or } V_{NC})]$. See Figure 4.
5. Between any two switches. See Figure 5.

Electrical Specifications - Single +2.5V Supply

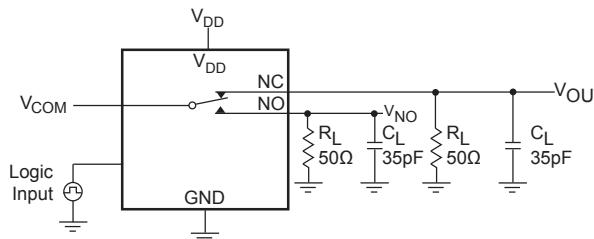
 (V_{DD} = +2.5V ± 10%, GND = 0V, V_{IH} = 1.4V, V_{IL} = 0.5V)

Parameter	Symbol	Conditions	Min. ⁽¹⁾	Typ. ⁽²⁾	Max. ⁽¹⁾	Units
Analog Switch						
Analog Signal Range ⁽³⁾	V _{ANALOG}		-1		V _{DD}	V
On-Resistance	R _{ON}	V _{DD} = 2.5V, I _{COM} = -8mA, V _{NO} or V _{NC} = 1.8V		0.9		Ω
On-Resistance Match Between Channels ⁽⁴⁾	ΔR _{ON}	V _{DD} = 2.5V, I _{COM} = -8mA, V _{NO} or V _{NC} = 0.8V, 1.8V		0.1		
On-Resistance Flatness ⁽⁵⁾	R _{FLAT(ON)}			0.01		
Dynamic						
Turn-On-Time	t _{ON}	V _{DD} = 2.5V, V _{NO} or V _{NC} = 1.8V, Figure 1			50	ns
Turn-Off-Time	t _{OFF}					
Break-Before-Make	t _{BBM}	Figure 3	1		20	
Charge Injection ⁽³⁾	Q	C _L = 1nF, V _{GEN} = 0V, R _{GEN} = 0V, Figure 2		90		pC
Supply						
Positive Supply Current	I _{CC}	V _{DD} = 2.75V, V _{IN} = 0V or V _{DD} All Channels on or off	120	160	200	μA
Logic Input						
Input High Voltage	V _{IH}	Guaranteed Logic High Level	1.4			V
Input Low Voltage	V _{IL}	Guaranteed Logic Low Level			0.5	
Input High Current	I _{INH}	V _{IN} = V _{DD} , all others = 0V	-1		1	μA
Input Low Current	I _{INL}	V _{IN} = 0V, all others = V _{DD}	-1		1	

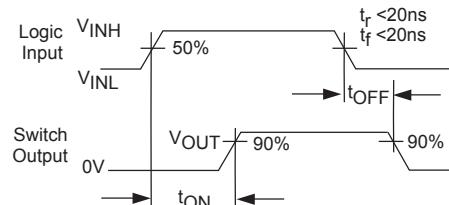
Parameter	Symbol	Conditions	Min. ⁽¹⁾	Typ. ⁽²⁾	Max. ⁽¹⁾	Units
Positive Supply Current	I _{CC}	V _{DD} = 1.5V, V _{IN} = 0V or V _{DD}	70	350	400	μA

Notes:

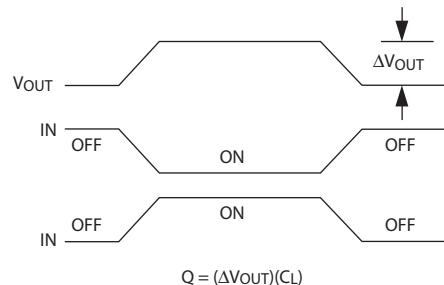
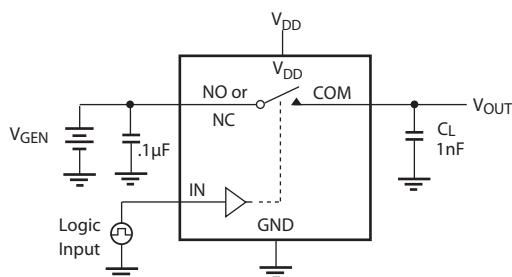
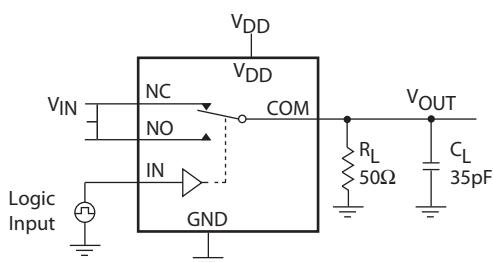
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T_A = 40°C to +85°C.
2. Typical values are for DESIGN AID ONLY, not guaranteed or subject to production testing.
Typical values are tested w T_A = 25°C
3. Guaranteed by design.
4. ΔR_{ON} = R_{ON} max. - R_{ON} min.
5. Flatness is defined as the difference between the maximum and minimum value of On-Resistance measured.

Test Circuits/Timing Diagrams


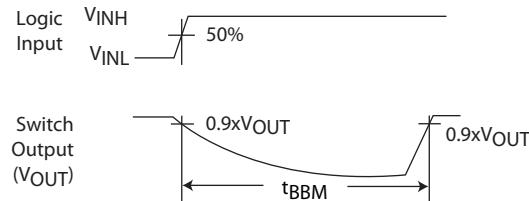
C_L INCLUDES FIXTURE AND STRAY CAPACITANCE
 $V_{OUT} = V_{NO} \left(\frac{R_L}{R_L + R_{ON}} \right)$

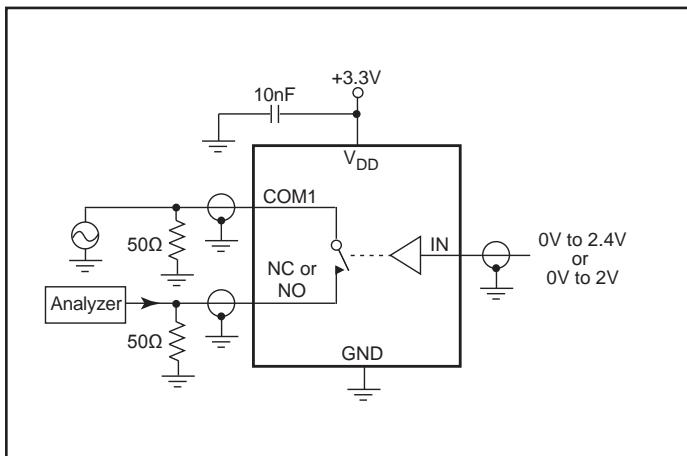
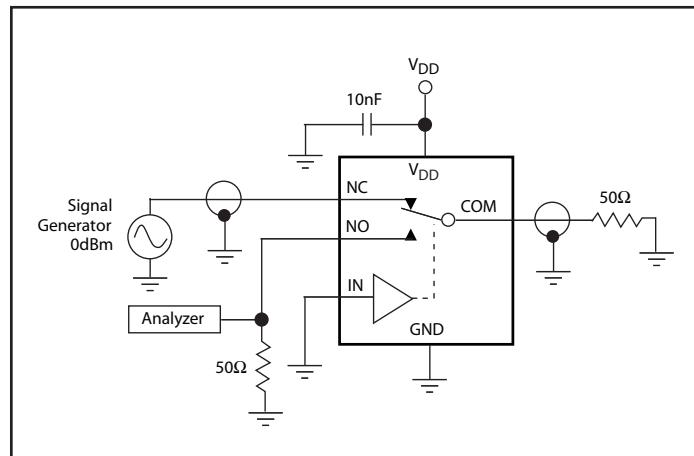
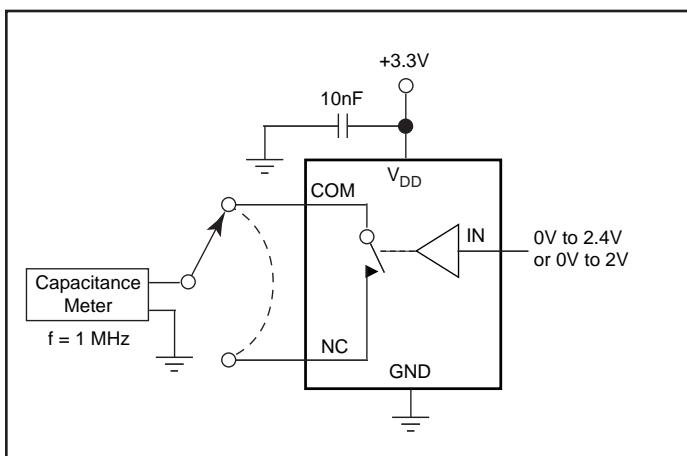
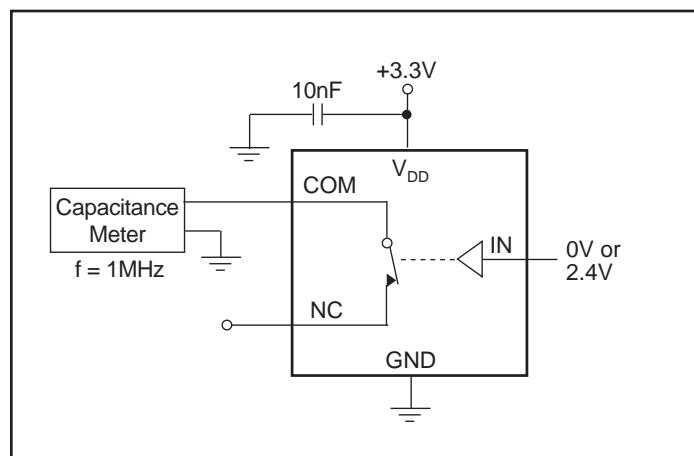
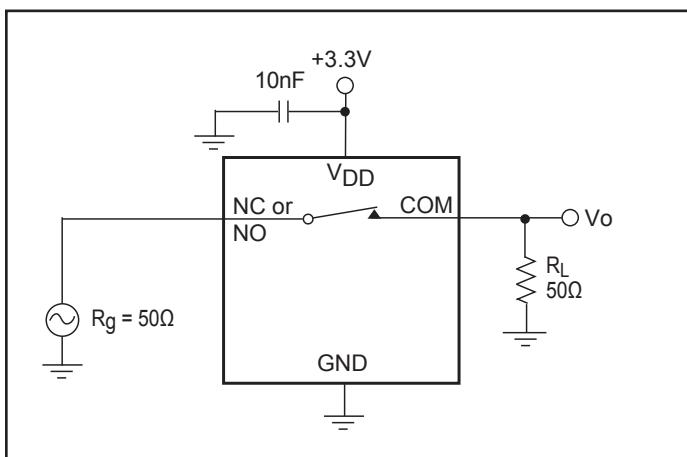


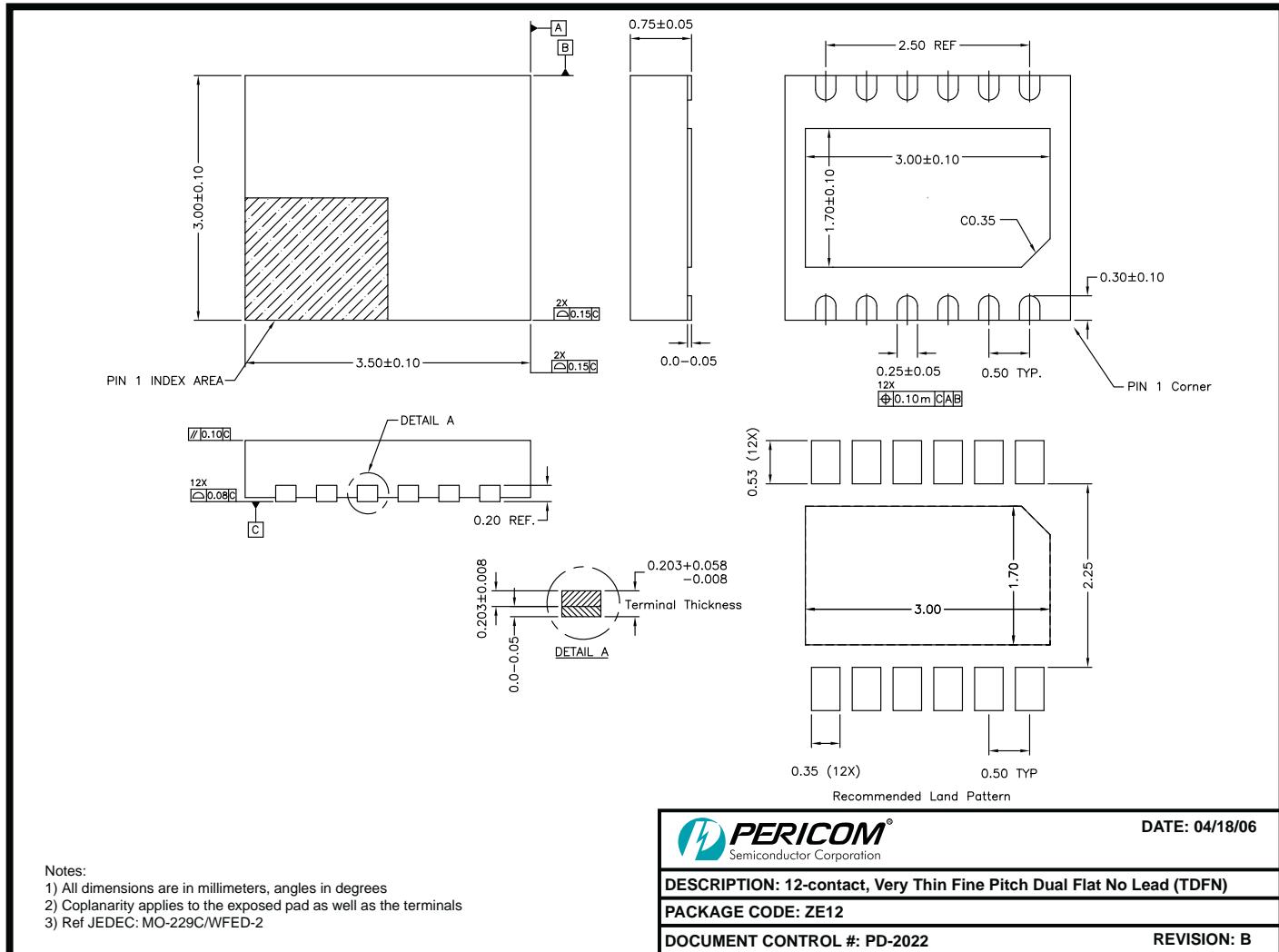
LOGIC INPUT WAVEFORMS INVERTED FOR
 SWITCHES THAT HAVE OPPOSITE LOGIC
 * 1.5V FOR 3.3V SUPPLY

Figure 1. Switching Time

Figure 2. Charge Injection


C_L INCLUDES FIXTURE AND STRAY CAPACITANCE


Figure 3. Break-Before-Make Interval

Test Circuits/Timing Diagrams (continued)

Figure 4. Off Isolation/On-Channel Bandwidth

Figure 5. Crosstalk

Figure 6. Channel-Off Capacitance

Figure 7. Channel-On Capacitance

Figure 8. Bandwidth

Packaging Mechanical: 12-Contact TDFN (ZE)


06-0360

Note:

- For latest package info, please check: <http://www.pericom.com/products/packaging/mechanicals.php>

Ordering Information

Ordering Code	Package Code	Package Type	Top Mark
PI3A3160CZEEEX	ZE	Pb-free & Green, 12-contact TDFN	YH

Notes:

- Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- E = Pb-free and Green
- X suffix = Tape/Reel